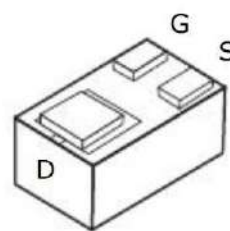


N-Channel Enhancement Mode MOSFET

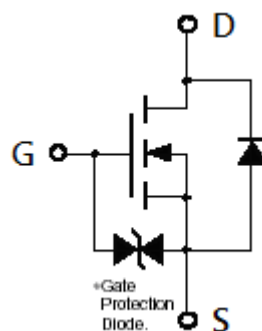
Description:

- Low voltage drive(2.5V drive) makes this device ideal for portable equipment.
- The MOSFET elements are independent, eliminating mutual interference.
- Mounting cost and area can be cut in half.
- High speed switching
- ESD protected device, HBM $\geq$ 2kV
- Pb-free lead plating & halogen-free package

WBFBP-03E



BV _{DSS}		60V
I _D @V _{GS} =4.5V, T _A =25°C		215mA
R _{DS(on)} (TYP)	V _{GS} =4.5V, I _D =200mA	1.3Ω
	V _{GS} =2.5V, I _D =100mA	1.7Ω



G : Gate S : Source D : Drain

Ordering Information

Device	Package	Shipping
KWAK6	WBFBP-03E (Pb-free lead plating & halogen-free package)	10000 pcs / Tape & Reel

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	BV _{DSS}	60	V
Gate-Source Voltage	V _{GS}	±20	
Continuous Drain Current	I _D	215	mA
Pulsed Drain Current	I _{DM}	860 *1	
Total Power Dissipation	P _D	150 *2	mW
ESD susceptibility	V _{ESD}	2000 *3	V
Operating Junction and Storage Temperature Range	T _j ; T _{stg}	-55~+150	°C

Note : *1. Pulse Width ≤ 10μs, Duty cycle ≤ 1%

*2. With each pin mounted on the recommended lands.

*3. Human body model, 1.5kΩ in series with 100pF

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-case, max	*R _{θJC}	270	°C/W
Thermal Resistance, Junction to Ambient, max	*R _{θJA}	833	

Note : With each pin mounted on the recommended lands.

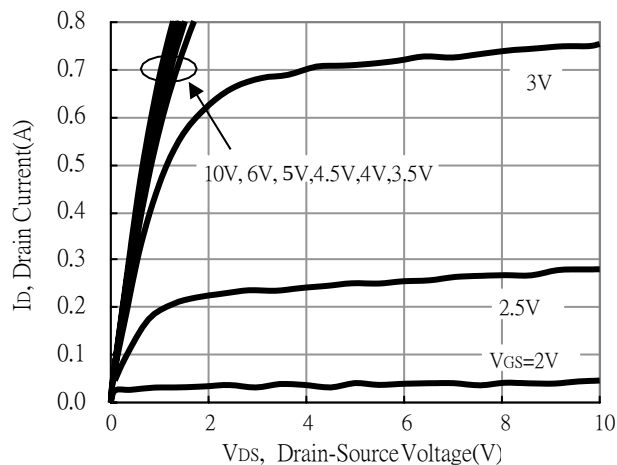
Electrical Characteristics (Ta=25°C)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Static					
BV _{DSS}	60	-	-	V	V _{GS} =0V, I _D =250μA
V _{GS(th)}	0.5	-	1.5		I _D =250μA, V _{DS} =V _{GS}
I _{GSS}	-	-	±10	μA	V _{GS} =±16V, V _{DS} =0V
I _{DSS}	-	-	1		V _{DS} =60V, V _{GS} =0V
R _{DS(ON)}	-	1.3	3	Ω	V _{GS} =4.5V, I _D =200mA
	-	1.7	5.1		V _{GS} =2.5V, I _D =100mA
G _{FS}	100	322	-	mS	V _{DS} =5V, I _D =100mA
Dynamic					
C _{iss}	-	25.8	-	pF	V _{DS} =25V, V _{GS} =0V, f=1MHz
C _{oss}	-	8.6	-		
C _{rss}	-	7	-		
t _{d(on)}	-	3.1	-	ns	V _{DD} =30V, I _D =200mA, V _{GS} =10V, R _G =25Ω
t _r	-	15.1	-		
t _{d(off)}	-	11.4	-		
t _f	-	18	-		
*Q _g	-	1.6	-	nC	V _{DS} =30V, I _D =200mA, V _{GS} =10V
*Q _{gs}	-	0.4	-		
*Q _{gd}	-	0.2	-		
R _g	-	3	-	Ω	f=1MHz
Source-Drain Diode					
*V _{SD}	-	0.79	1.2	V	V _{GS} =0V, I _S =100mA
*t _{rr}	-	8.3	-	ns	I _F =0.5A, dI _F /dt=100A/μs
*Q _{rr}	-	2.7	-	nC	

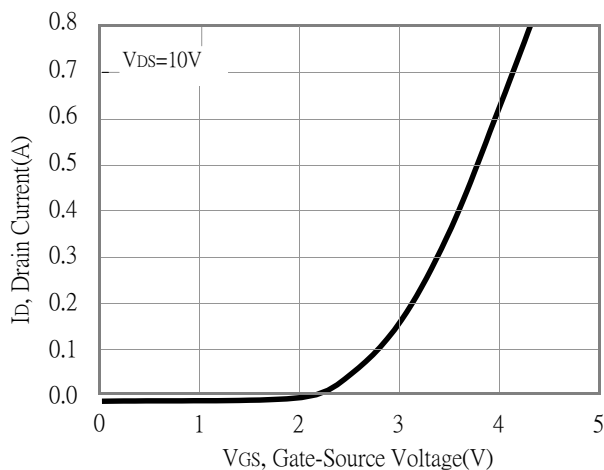
*Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 2%

Typical Characteristics

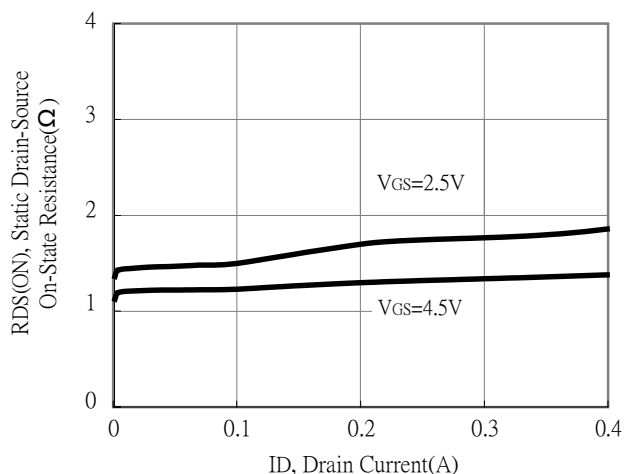
Typical Output Characteristics



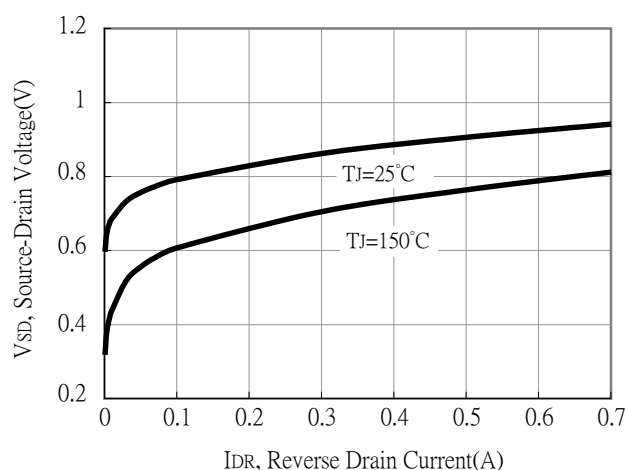
Typical Transfer Characteristics



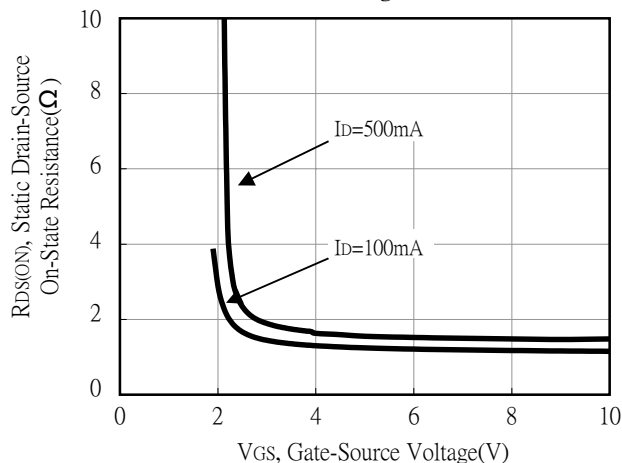
Static Drain-Source On-State resistance vs Drain Current



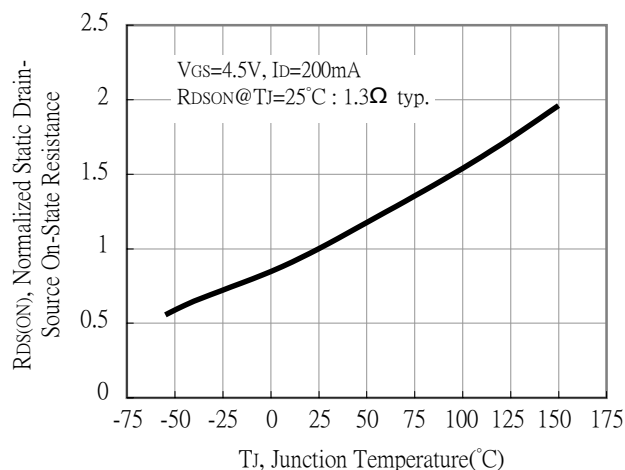
Reverse Drain Current vs Source-Drain Voltage



Static Drain-Source On-State Resistance vs Gate-Source Voltage

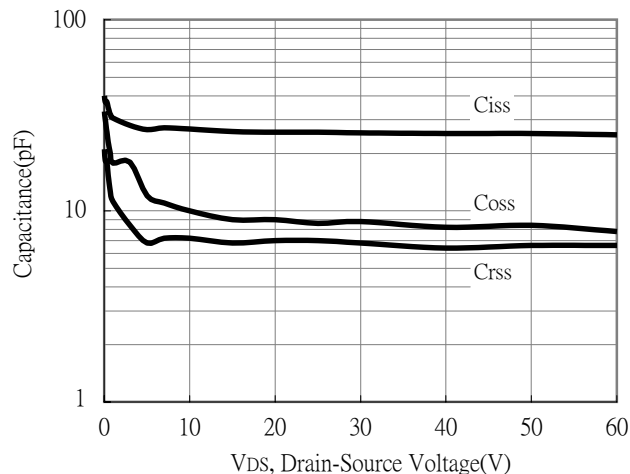


Drain-Source On-State Resistance vs Junction Temperature

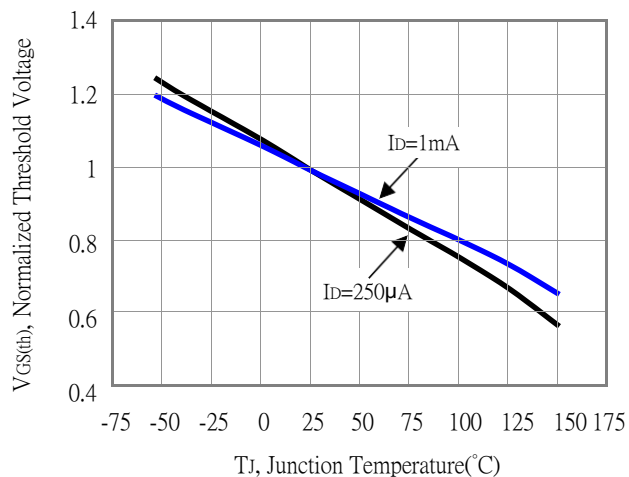


Typical Characteristics(Cont.)

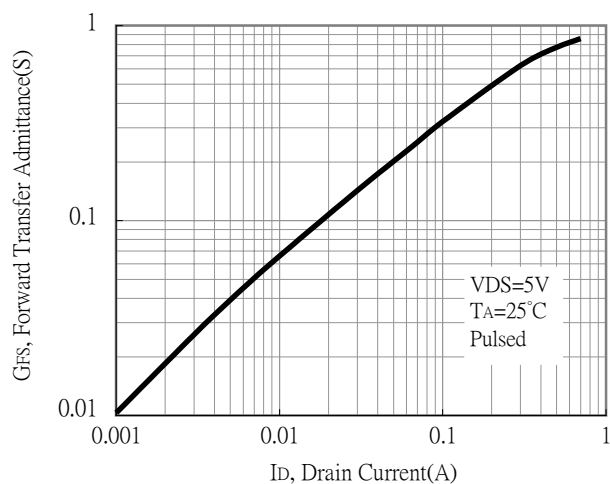
Capacitance vs Drain-to-Source Voltage



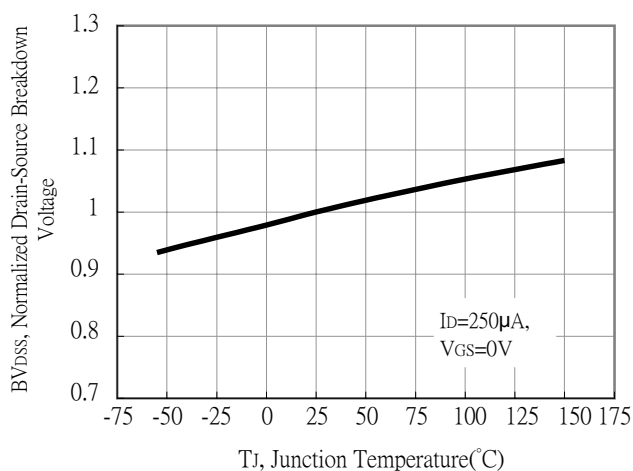
Threshold Voltage vs Junction Temperature



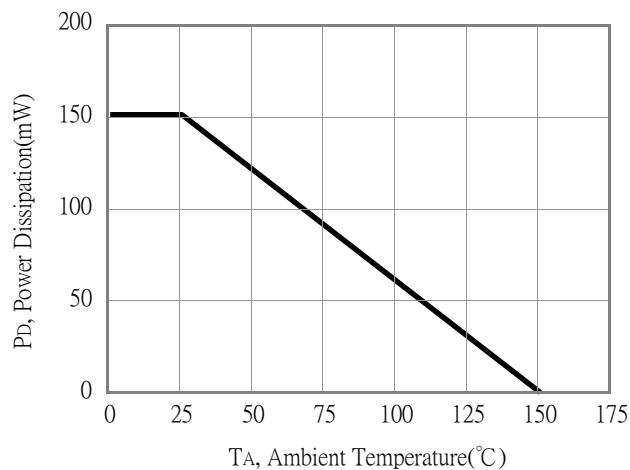
Forward Transfer Admittance vs Drain Current



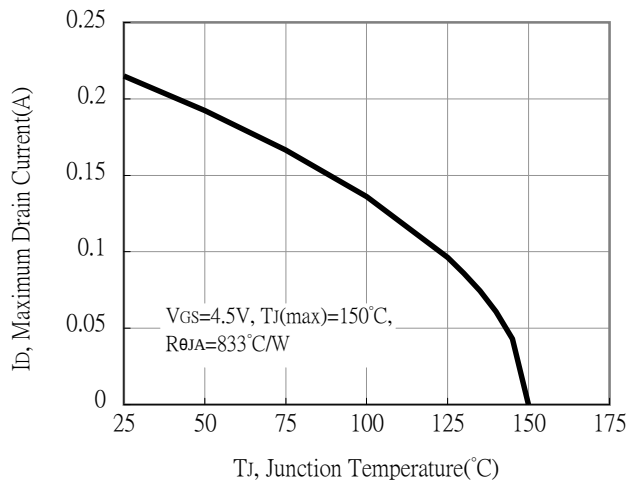
Brekdown Voltage vs Ambient Temperature



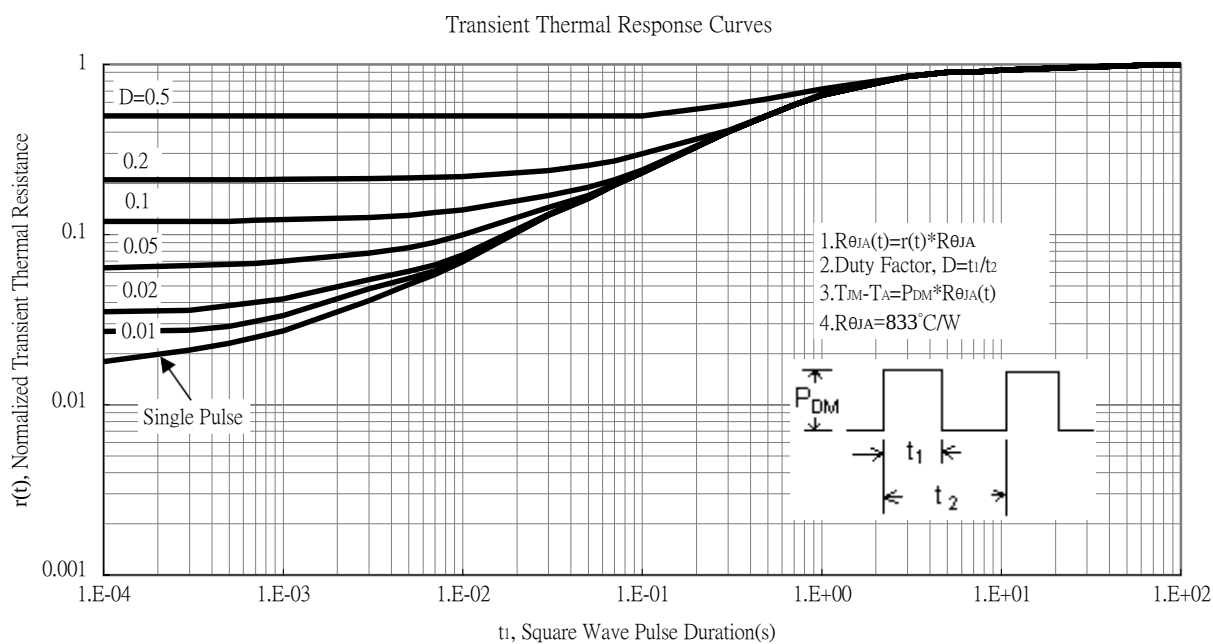
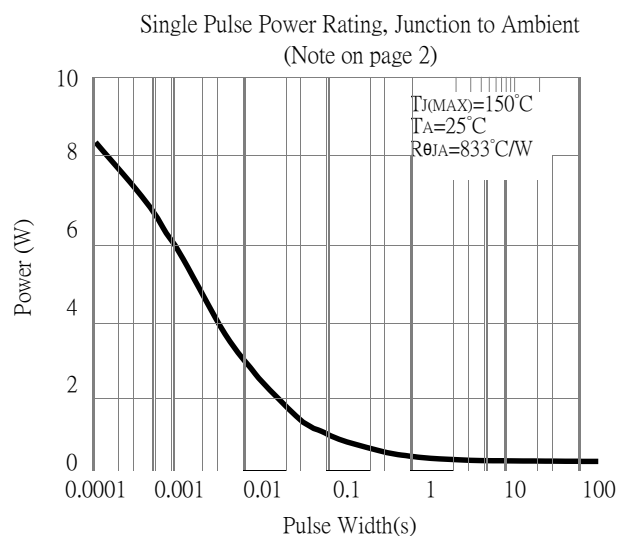
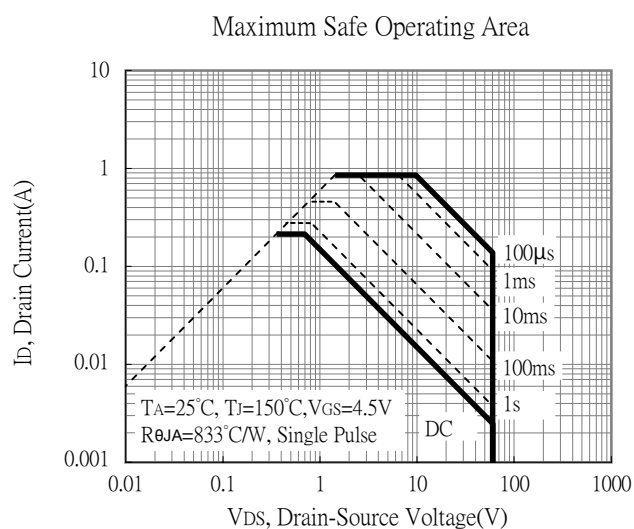
Power Derating Curve



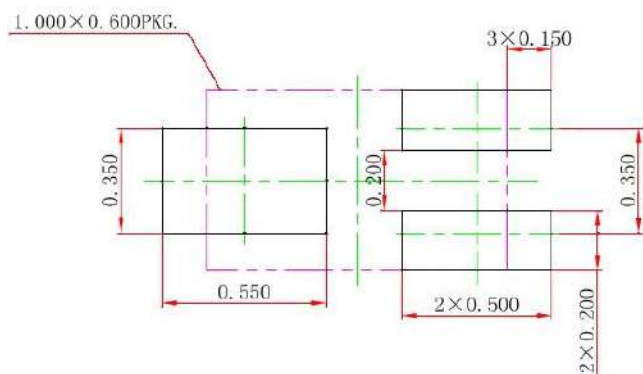
Maximum Drain Current vs Junction Temperature



Typical Characteristics(Cont.)



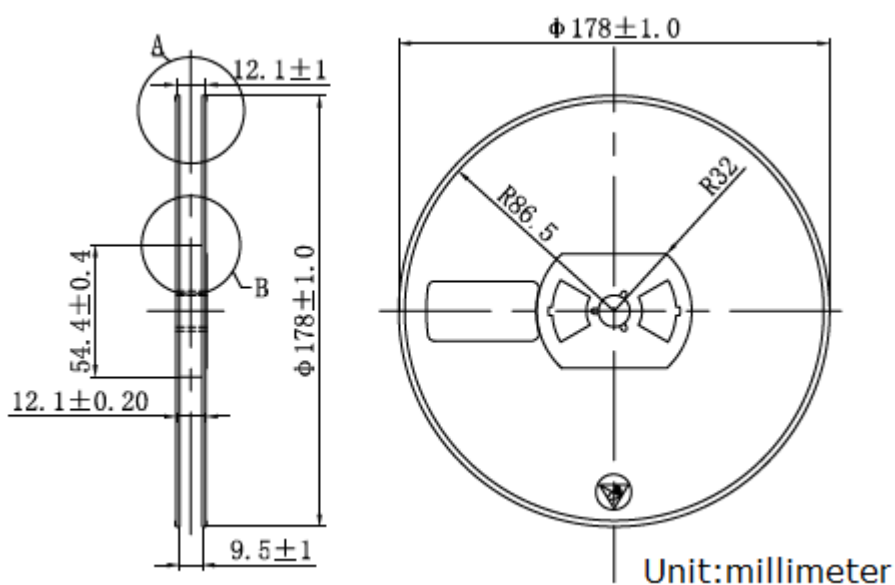
Recommended Soldering Footprint



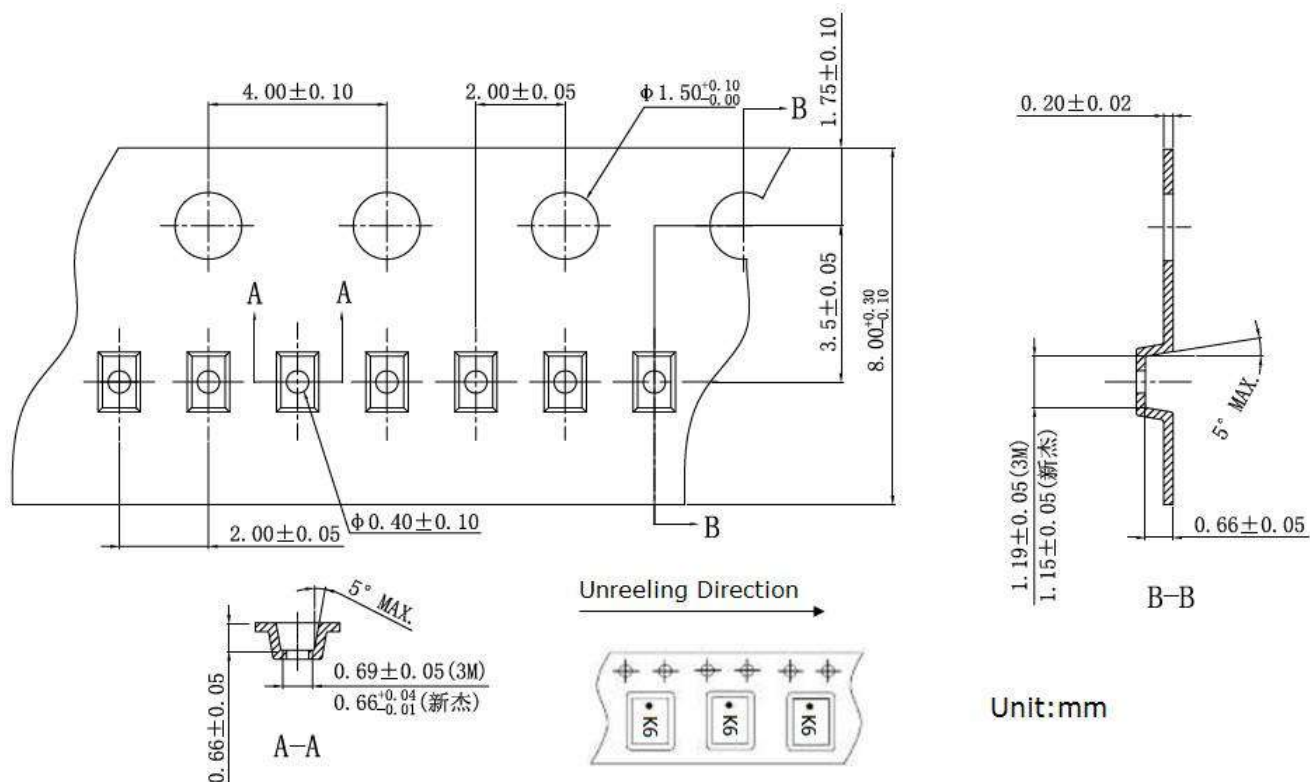
Note:

- Controlling dimension: in millimeters.
- General tolerance: $\pm 0.050\text{mm}$.
- The pad layout is for reference purposes only.

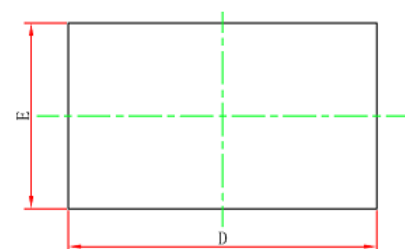
Reel Dimension



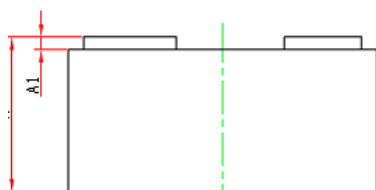
Carrier Tape Dimension



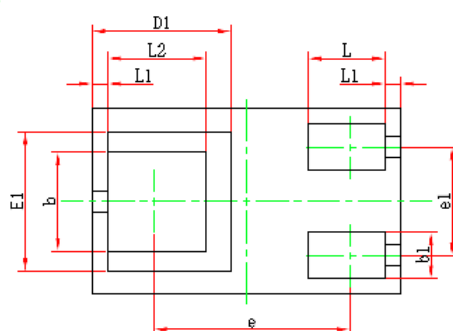
WBFBP-03E Dimension



TOP VIEW

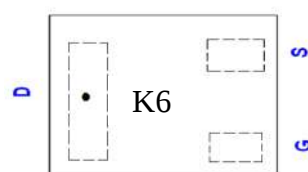


SIDE VIEW



BOTTOM VIEW

Marking:



3-Lead WBFBP-03E Plastic
Surface Mounted Package

Style: Pin 1.Gate 2.Source 3.Drain

*: Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.018	0.022	0.450	0.550	b1	0.004	0.008	0.100	0.200
A1	0.000	0.004	0.010	0.100	e	0.025REF		0.635REF	
D	0.037	0.041	0.950	1.050	e1	0.012	0.016	0.300	0.400
E	0.022	0.026	0.550	0.650	L	0.008	0.012	0.200	0.300
D1	0.018REF		0.450REF		L1	0.002REF		0.050REF	
E1	0.018REF		0.450REF		L2	0.011	0.015	0.270	0.370
b	0.011	0.015	0.270	0.370					